

# L-Band, GaN/SiC, RF Power Transistor

1.2 - 1.4 GHz | 2000 W typ | 70 % Efficiency typ | 17 dB Gain typ | 100 V | 100 µs Pulse Length, 10% Duty Cycle

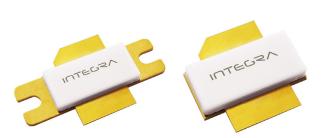
IGN1214M1600 and IGN1214M1600S are high power GaN-on-SiC RF power transistors that have been designed to suit the unique needs of modern long-range radar systems. They supply a minimum of 1600 W of peak output power, with typically >17 dB of associated gain and 65% efficiency. They operate from a 100 V supply voltage. For optimal thermal efficiency, the transistors are housed in a metal-based package with an epoxy-sealed ceramic lid.

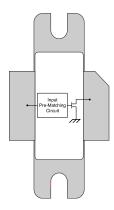
## **FEATURES**

- GaN on SiC HEMT Technology
- Output Power >1600 W
- Pre-matched Input Impedance
- High Efficiency up to 70%
- 100% RF Tested under 100µs, 10% duty cycle pulse conditions
- RoHS and REACH Compliant
- Full non-linear electrothermal model available, please contact the factory

## **APPLICATIONS**

L-band Radar Systems





| Parameter               | Symbol   | Min  | Тур   | Max  | Units | Test Conditions                   |
|-------------------------|----------|------|-------|------|-------|-----------------------------------|
| Gain                    | G        | 16   | 17    | 18   | dB    |                                   |
| Drain Efficiency        | η        | 60   | 65    | 75   | %     | P <sub>out</sub> = 1600W          |
| Pulse Droop             | D        | -0.5 | -0.35 | +0.2 | dB    | f = 1.2, 1.3, 1.4 GHz             |
| Input Return Loss       | IRL      | 10   | 15    | 20   | dB    | 100μs pulse length 10% duty cycle |
| Load Mismatch Stability | VSWR-S   | 2:1  |       |      |       | pulse conditions                  |
| VSWR Withstand          | VSWR-LMT | 5:1  |       |      |       | $V_{DS} = 100V, I_{DS} = 75mA$    |
| Second Harmonic         |          |      | -25   |      | dBc   |                                   |
| Third Harmonic          |          |      | -38   |      | dBc   |                                   |

## Table 1. RF Electrical Characteristics (Case temperature = 30 °C unless otherwise stated)

Note: Consult Integra Technologies Application Note 001 for information on how RF output power and pulse droop are measured.



## Table 2. Absolute Maximum Ratings (Not Simultaneous)

| Parameter                     | Symbol              | Value       | Units | Test Conditions |
|-------------------------------|---------------------|-------------|-------|-----------------|
| DC Drain-Source Voltage       | V <sub>DS</sub>     | 400         | V     | 25 ⁰C           |
| DC Gate-Source Voltage        | V <sub>GS</sub>     | -8 to +1    | V     | 25 °C           |
| DC Drain Current              | I <sub>D</sub>      | 78          | A     | 25 °C           |
| DC Gate Current               | Ι <sub>G</sub>      | 78          | mA    | 25 °C           |
| RF Input Power                | P <sub>RFIN</sub>   | 40          | W     | 25 ⁰C           |
| Operating Channel Temperature | Т <sub>сн</sub>     | -55 to +225 | ٥C    |                 |
| Storage Temperature           | T <sub>stg</sub>    | -55 to +150 | °C    |                 |
| Soldering Temperature         | T <sub>SOLDER</sub> | 260 for 60s | °C    |                 |

Note: Operation outside the limits given in this table may cause permanent damage to the transistorS

## Table 3. DC Electrical Characteristics (Case temperature = 25 °C unless otherwise stated)

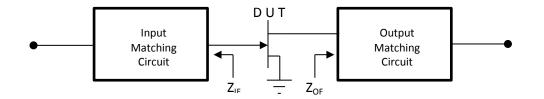
| Parameter              | Symbol         | Min  | Тур  | Мах | Units | Test Conditions                                 |
|------------------------|----------------|------|------|-----|-------|---|
| Gate Pinch-Off Voltage | V <sub>P</sub> | -5.0 |      |     | V     | $V_{_{\rm DS}} = 100$ V, $I_{_{\rm DS}} = 1$ mA |
| Quiescent Gate Voltage | V <sub>Q</sub> |      | -2.8 |     | V     | V <sub>DS</sub> = 100V, I <sub>DS</sub> = 75mA  |

## Table 4. Thermal Resistance (Case temperature = 85 °C unless otherwise stated)

| Parameter                                   | Symbol          | Тур | Units | Test Conditions  |
|---|-----------------|-----|-------|--|
| Peak Thermal Resistance,<br>Channel to Case | R <sub>TH</sub> | 0.1 | ⁰C/W  | $P_{_{DISS}} = 980W$<br>100µs pulse length, 10% duty cycle<br>$V_{_{DS}} = 100V$ |

#### Table 5. Standard Test Fixture Source & Load Impedances (Case temperature = 25 °C unless otherwise stated)

| Frequency (GHz) | Z <sub>IF</sub> | Z <sub>oғ</sub><br>Fundamental | Z <sub>o⊧</sub><br>Second Harmonic | Units | Test Conditions  |
|-----------------|-----------------|--------------------------------|------------------------------------|-------|--|
| 1.2             | 1.25 - j 1.48   | 2.18 - j 2.87                  | 1.08 + j 1.65                      | Ω     | P <sub>our</sub> = 1600W   |
| 1.3             | 1.16 - j 0.64   | 2.09 - j 2.70                  | 0.99 + j 3.58                      | Ω     | 100μs pulse length, 10% duty cycle<br>$V_{ps} = 100V$ , $I_{ps} = 75$ mA |
| 1.4             | 1.11 + j 0.14   | 2.06 - j 1.67                  | 1.51 + j 5.02                      | Ω     |  |





## **TYPICAL PERFORMANCE**

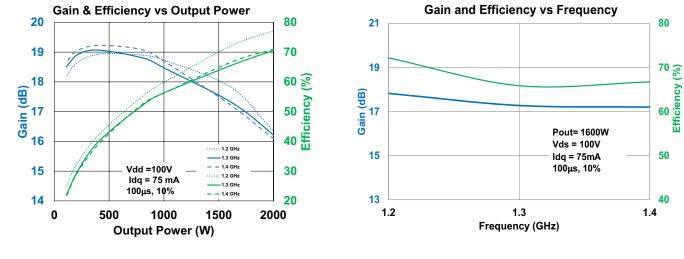


Figure 1.

Figure 2.

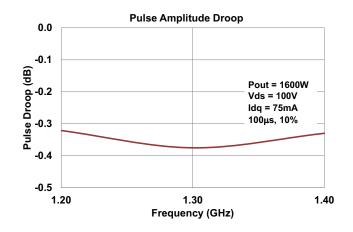
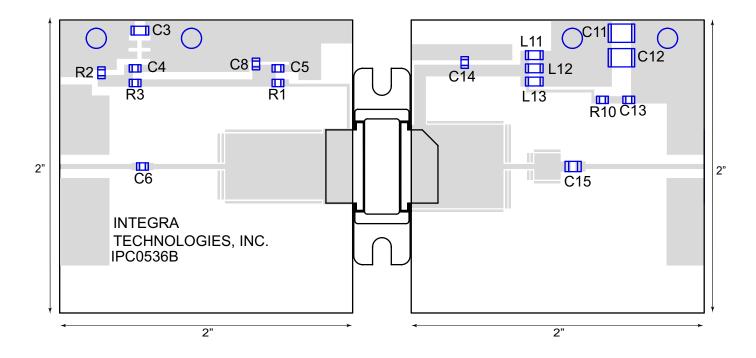


Figure 3.





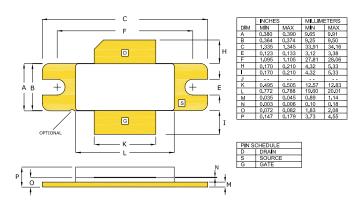


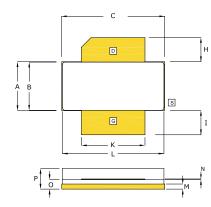
## Bill of Materials for IGN1214M1600 Test Fixture

| Designator    | Description                        | Part Number      |
|---------------|------------------------------------|------------------|
| С3            | CAP 1µF, 1206, 100V , X7R          | 12061C105K4T2A   |
| C4, C13       | CAP 0.068μF, 0805, 250V, X7R       | C0805C683KARAC#A |
| C5, C6, C14   | CAP 33pF, 0805, 100V               | ATC600F330       |
| C8            | CAP 1000pF, 0805, 100V             | 08051A102J4T2A   |
| C11, C12      | CAP 1µF, 1812, 200V, X7R           | 18122C105KAT2A   |
| C15           | CAP 150pF, 1111                    | 800B151JT300XT   |
| L11, L12, L13 | IND FB 38 OHM, 6A, 1206            | Z1206C380BPWST   |
| R1, R10       | RES 15Ω, 0805                      | CRCW080515R0JNEA |
| R2            | RES 100Ω, 0805                     | CRCW0805100RFKTA |
| R3            | RES 0Ω, 0805                       | CRCW08050000ZSTA |
| PC Board      | ROGERS RO3006 25mil, 2/2oz. Copper |                  |



PACKAGE PL84A1





|     | INCHE | S     | MILLIM | MILLIMETERS |  |  |
|-----|-------|-------|--------|-------------|--|--|
| DIM | MIN   | MAX   | MIN    | MAX         |  |  |
| А   | 0.380 | 0.390 | 9.65   | 9.91        |  |  |
| В   | 0.364 | 0.374 | 9.25   | 9.50        |  |  |
| С   | 0.805 | 0.815 | 20.45  | 20.70       |  |  |
| E   |       |       |        |             |  |  |
| F   |       |       |        |             |  |  |
| н   | 0,170 | 0,210 | 4.32   | 5.33        |  |  |
| 1   | 0,170 | 0,210 | 4,32   | 5,33        |  |  |
| J   |       |       |        |             |  |  |
| К   | 0.495 | 0.505 | 12.57  | 12,83       |  |  |
| L   | 0.772 | 0.788 | 19,60  | 20.01       |  |  |
| м   | 0.035 | 0.045 | 0.89   | 1.14        |  |  |
| N   | 0.003 | 0.006 | 0.10   | 0.18        |  |  |
| 0   | 0.072 | 0.082 | 1.83   | 2.08        |  |  |
| Р   | 0.147 | 0.179 | 3.73   | 4.55        |  |  |

| PIN SCHEDULE |        |  |  |  |
|--------------|--------|--|--|--|
| D            | DRAIN  |  |  |  |
| S            | SOURCE |  |  |  |
| G            | GATE   |  |  |  |

## BOLT-DOWN FLANGE OPTION IGN1214M1600

# EARLESS FLANGE OPTION IGN1214M1600S



## **ESD & MSL Rating**

| Parameter                       | Rating               | Standard               |
|---------------------------------|----------------------|------------------------|
| ESD Human Body Model (HBM)      | TBD                  | ESDA/JEDEC JS-001-2012 |
| ESD Charged Device Model (CDM)  | TBD                  | JEDEC JESD22-C101F     |
| Moisture Sensitivty Level (MSL) | Unlimited Shelf Life | IPC/JEDEC J-STD-020    |

## **RoHS Compliance**

Integra Technologies, Inc declares that its GaN and LDMOS Transistor Products comply with EU Directive 2011/65/EU on the restriction of the use of certain hazardous substances in electrical and electronic equipment (RoHS2), as adopted by EU member states on January 2, 2013 and amended on March 31, 2015 by EU Directive 2015/863/EU.

## **REACH Compliance**

Integra Technologies supports EU Regulation number 1907/2006 concerning the Registration, Evaluation, Authorization, and Restriction of Chemicals (REACH) as these apply to Integra semiconductor products, development tools, and shipping packaging.

In support of the REACH regulation, Integra will:

- Inform customers and recipients of Integra product if they contain any substances that are of very high concern (SVHC) per the European Chemical Agency (ECHA) website.
- •Notify ECHA if any Integra product that contains any SVHCs which exceed guidelines for REACH chemicals by weight per part number and for total content weight per year for all products produced in or imported to the European market.
- •Cease shipments of product containing REACH Annex XIV substances until authorization has been obtained.
- •Cease shipment of product containing REACH Annex XVII chemicals when restrictions apply.

Integra has evaluated its materials, BOMs, and product specifications and product and has determined that this transistor conforms to all REACH and SVHC regulations and guidelines. Integra has implemented actions and control programs that will assure continued compliance.

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DEFINITIONS:

DATA SHEET STATUS

Advanced Specification - This data sheet contains Advanced specifications.

Preliminary Specification - This data sheet contains specifications based on preliminary measurements and data.

Final Specification - This data sheet contains final product specifications.

MAXIMUM RATINGS Stress above one or more of the maximum ratings may cause permanent damage to the device. These are maximum ratings only operation of the device at these or at any other conditions above those given in the characteristics sections of the specification is not implied. Exposure to maximum values for extended periods of time may affect device reliability.

Integra Technologies, 321 Coral Circle, El Segundo, CA 90245-4620 | Phone: 310-606-0855 | Fax: 310-606-0865